



2FF SIM CARD

RECOMMEND PCB LAYOUT
TOLERANCE $\pm 0.05\text{MM}$

A.Material:

1.Insulator: Hing temperature thermoplastic
UL94V-0(BLACK LCP)

2.Pho.Bronze: Plating,40u"MIN nikel underplated

CONTACT AREA: Au 1u"

SOLDER AREA: 80u" TIN

B.Electrical specifications

Voltage rating: 12V AC

Current rating: 0.5A

Dielectric strength: 250V AC for 1 minute min

Insulation resistance: 500M Ω

Contact resistance: 50m Ω max

Operation, temperature: -40°C TO 105°C

Product withstanding rflow soldering 260°C for 10S

C.Mechanical specifications: Durability:5000cycles

②	Terminal	6	COPPER ALLOY	
①	Housing	1	LCP UL 94V-0	BLACK
ITEM	PAPT NAMF	QTY	MATERIAL	FINISHING

广东星坤科技股份有限公司

Δ X		日期
生 Δ X		
变 Δ X		
MARK		

DESCRIPTION	DATE	REVISED	APPROVED	UNSPECIFIED TOLERANCES
				ANGLAR $\pm 5^\circ$
				L \leq 4 ± 0.2
				4<L \leq 16 ± 0.3
				16<L \leq 63 ± 0.4
				L> 63 ± 0.5

DSND		SCALE: N/A	MODEL TYPE:
DWN		VIEW:	SIM CARD CONN
CHKD		UNIT: mm/in	PART NO.:
APPD		SIZE: A4	DWG NO.: XKSIM-011B-P6
XKB INDUSTRIAL PRECISION CO., LIMITED			WEIGHT
			SHEET
			REVISION
			1/1
			A0



文件工程章